# ■ Naphome Phase II Manufacturing Specifications

Document Version: 1.0
Date: October 2025

Target Volume: 10,000 units

# ■ Executive Summary

**Product:** Naphome Smart Sleep Device

Architecture: ESP32-S3 + Cloud AI + Custom Audio/Lighting

**Manufacturing:** Full turnkey production (PCB  $\rightarrow$  Assembly  $\rightarrow$  Housing  $\rightarrow$  QA) **Certification:** FCC/CE compliant using pre-certified ESP32-S3 module

## **⚠** Product Overview

The Naphome is a premium smart sleep companion that combines: -Voice AI (cloud-based speech recognition and response) - Premium Audio (ND65/ND90 stereo speakers with passive radiators) - Dynamic RGB Lighting (circadian lighting with 10-16 WS2812B LEDs) - Environmental Sensing (6 sensors for bedroom optimization) -IoT Control (IR blaster for AC/TV control)

# ■ Technical Specifications

## **Core Hardware Requirements**

Component	Specification	Notes
MCU	ESP32-S3-WROOM-1 (8MB PSRAM)	Pre-certified module (FCC/CE)
Audio Amplifier	TAS5825M (I2S, 2×20W)	TI digital amplifier
Speakers	ND65 (Base) / ND90 (Premium) + Passive Radiators	Dual acoustic chambers
Microphones	2-3× Digital I <sup>2</sup> S MEMS	Far-field, noise- canceling
RGB LEDs	10x WS2812B (Base) / 16x WS2812B (Premium) in ring configuration	Addressable, 5V
Display	256×64 OLED (SSD1322 or equivalent)	SPI interface, 3.3V
Power	USB-C PD 12V + Li-ion backup	2-3 hours battery runtime
Connectivity	Wi-Fi 2.4GHz + BLE	Dual-band support

### **Sensor Suite (6 Total)**

Sensor	Part Number	Interface	Purpose
Temperature/Humidity	SHTC3	I <sup>2</sup> C	Environmental monitoring
VOC/CO <sub>2</sub>	SGP30 (Base) / SCD41 (Premium)	I <sup>2</sup> C	Air quality
Ambient Light	VEML7700	I <sup>2</sup> C	Circadian lighting control
PM2.5 Air Quality	PMS5003	UART	Air quality monitoring
Sound Level	MEMS Microphone	Analog	Noise monitoring
Display	256×64 OLED (SSD1322)	SPI	Status, time, visual feedback

Sensor Part Number Interface Purpose
IR Transmitter Custom IR LED + Driver GPIO IoT device control

#### **Audio Specifications**

**Parameter Base SKU Premium SKU Drivers** ND65 + Passive Radiators ND90 + Passive Radiators **Frequency Response** 60Hz - 20kHz 50Hz - 20kHz <1% @ 1W <0.5% @ 1W Sensitivity 85dB @ 1W/1m 88dB @ 1W/1m **Power Handling** 2×10W RMS 2×20W RMS **Acoustic Design** Dual chamber, ported Dual chamber, tuned 10× WS2812B in ring **LED Ring** 16× WS2812B in ring configuration configuration

## **RGB Lighting Specifications**

**Parameter Base SKU Premium SKU LED Count** 10× WS2812B 16× WS2812B **Power** 5V, 0.3W per LED 5V, 0.3W per LED Diffusion Frosted acrylic dome Enhanced diffuser + light pipe ESP32-S3 PWM ESP32-S3 PWM Control Ring layout around device Configuration Ring layout with enhanced spacing perimeter Circadian lighting, visual **Features** Enhanced diffusion, color accuracy feedback

## ■ Mechanical Specifications

## **Enclosure Requirements**

ParameterSpecificationMaterialPC/ABS blend (UL94 V-0)Dimensions~150×150×200mm (TBD)

Weight <1.5kg

Finish Matte white/black, soft-touch

Assembly Snap-fit + screws (serviceable)

IP Rating IP20 (indoor use)

#### **Acoustic Design**

Component Specification

Speaker Enclosure Dual acoustic chambers, ported

2-3 mics, 120° spacing, acoustic isolation

Vibration Isolation Rubber feet, internal damping

Thermal Management Passive cooling, thermal pads

## **Connectors & Controls**

Component Specification

Power Input USB-C PD (12V, 3A)

Touch Controls 3× capacitive touch buttons

Volume Control Rotary encoder (360°, detented)

Component **Specification** 

256×64 OLED (status, time, **Display** 

feedback)

Status LEDs Power, Wi-Fi, RGB feedback Reset Button Recessed, factory reset

# **⚠** PCB Specifications

## **Board Requirements**

**Parameter Specification** 

Layers 4-layer PCB Thickness 1.6mm

Material FR4, Tg 150°C **Finish** HASL or ENIG ~80×100mm (TBD) Size Assembly SMT + selective hand assembly

### **Component Placement**

Zone Components **MCU Zone** ESP32-S3, crystal, flash, PSRAM Audio Zone TAS5825M, audio connectors, filtering Sensor Zone I<sup>2</sup>C sensors, level shifters, pull-ups Display Zone OLED display, SPI interface, level shifters

USB-C controller, buck/boost, battery **Power Zone** 

management

Interface Connectors, buttons, LEDs

Zone

## **Power Management**

Rail	Voltage	Current	Components
VBUS	12V (USB-C PD)	3A	Input from USB-C
VCC_3V3	3.3V	1A	ESP32-S3, sensors
VCC_5V	5V	2A	RGB LEDs, audio amp
VCC_3V3_DISP	3.3V	100mA	OLED display
VBAT	3.7V	2A	Li-ion battery

# 

## **Electrical Testing**

Test	Specification	Method
Power Consumption	<15W @ 12V	Digital multimeter
Display Brightness	100-300 cd/m <sup>2</sup>	Luminance meter
Audio THD	<1% @ 1W	Audio analyzer
Wi-Fi Range	>30m @ 2.4GHz	RF chamber
<b>Battery Runtime</b>	>2 hours	Load testing
<b>Sensor Accuracy</b>	±2% (temp), ±5% (humidity)	Calibrated references

## **Acoustic Testing**

Test	Specification	Method
Frequency Response	60Hz-20kHz (Base), 50Hz-20kHz (Premium)	Anechoic chamber
Wake Word Detection	>95% @ 3m, 60dB ambient	Controlled environment
Microphone Sensitivity	-26dBV @ 1kHz	Audio analyzer
Audio Latency	<100ms (cloud round-trip)	Network testing

## **Environmental Testing**

Test	Condition	Duration	Pass Criteria
Temperature	-10°C to +50°C	24h	Full functionality
Humidity	10% to 90% RH	24h	No condensation
Vibration	5-500Hz, 1g	2h	No mechanical failure
<b>Drop Test</b>	1m onto concrete	3 drops	Cosmetic damage only

## **RGB Lighting Testing**

Test	Specification	Method
Color Accuracy	CRI >90	Spectrophotometer
Brightness	100-1000 lux @ 1m	Lux meter
Diffusion	Uniform light distribution	Visual inspection
Power Consumption	n <3W @ full brightness	Power meter

## **Display Testing**

Test	Specification	Method
Resolution	256×64 pixels	Visual inspection
Contrast Ratio	>1000:1	Contrast meter
Viewing Angle	>160° horizontal, >120° vertical	Goniometer
Response Time	<1ms	Oscilloscope
Power Consumption	<50mW @ full brightness	Power meter

# 

## **Packaging Requirements**

•	•	
Box	Recycled cardboard,	FSC certified

**Specification** 

Material **Box Size** ~200×200×250mm **Protection** EPE foam inserts

Accessories USB-C cable, quick start guide FCC/CE marks, model number, Labels

### **Documentation**

Component

Document	Language	Content
<b>Quick Start Guide</b>	English	Setup, Wi-Fi, basic usage

**Document** Language Content **User Manual** English Full feature documentation

Warnings, disposal, Safety Information English

compliance

1-year limited warranty **Warranty Card** English

# **⚠** Manufacturing Process

### **Production Flow**

- 1. PCB Assembly
  - SMT placement (pick & place)Reflow soldering

  - AOI inspection
  - ICT testing
- 2. Audio Assembly

  - Speaker mountingAcoustic chamber assembly
  - Microphone array installationAudio testing
- 3. Sensor Integration
  - Sensor mounting
  - Cable routing
  - Calibration
  - Functional testing
- 4. Final Assembly
  - PCB installation
  - Enclosure assembly
  - Button/control installation
  - Final testing
- 5. Quality Control
   Electrical testing
  - Acoustic testing
  - Environmental testing
  - Packaging

## **Yield Targets**

Stage	Target Yield	Action if Below
PCB Assembly	>98%	Rework/replace
<b>Audio Assembly</b>	>95%	Recalibrate
Final Assembly	>97%	Process improvement
Final Testing	>99%	Root cause analysis

# **⚠** BOM Components

## **Base SKU Components**

Components
ESP32-S3, TAS5825M, ND65 speakers
SHTC3, SGP30, VEML7700, PMS5003, MEMS mic
10× WS2812B, diffuser, driver
256×64 OLED, driver, mounting
Enclosure, buttons, connectors
USB-C, battery, power management

## **Premium SKU Components**

Components Category

MCU & ESP32-S3, TAS5825M, ND90 speakers Audio

SHTC3, SGP30, SCD41, VEML7700, PMS5003, MEMS mic Sensors

16× WS2812B, enhanced diffuser, light pipe Lighting

**Display** 256×64 OLED, driver, mounting Mechanical Enhanced enclosure, premium buttons

**Power** Enhanced power management

# ⚠ Compliance & Certification

## **Required Certifications**

Standard Scope Method Pre-certified ESP32-S3 FCC Part 15 RF emissions module Electromagnetic **CE EMC Declaration of Conformity** compatibility **CE LVD** Internal testing Low voltage directive

Restriction of hazardous **RoHS** Material declaration substances Material declaration **REACH** Chemical safety

## **Testing Requirements**

Standard **Pass Criteria** RF Emissions FCC Part 15 Class < FCC limits RF Immunity IEC 61000-4-3 No degradation ±8kV contact, ±15kV **ESD** 

IEC 61000-4-2

IEC 61000-4-5 ±2kV differential Surge

## **⚠** Timeline & Milestones

#### **Phase II Production Timeline**

**Milestone Duration Deliverables** Tooling 8 weeks Injection molds, test fixtures **EVT** 4 weeks Engineering validation units DVT 6 weeks Design validation, acoustic tuning

**PVT** 4 weeks 500-unit pilot run

16 MP 10,000 units production weeks

### **Key Deliverables**

Phase	Deliverable	Quantity
EVT	Engineering samples	50 units
DVT	Design validation	200 units
PVT	Production validation	500 units
MP	Mass production	10,000 units

# **⚠** Contact Information

### **Technical Lead**

**Daniel McShan** 

Email: dan@syzygyx.com

Services: Hardware design, firmware development, manufacturing liaison

## ■ Notes & Assumptions

## **Key Assumptions**

- ESP32-S3-WROOM-1 module is pre-certified (FCC/CE)
  10,000 unit minimum order quantity
- 12-month production timeline
- Standard payment terms (30% deposit, 70% on delivery)
  1-year warranty on all components

## **Risk Mitigation**

- Multiple supplier options for critical components
- Pre-production validation at each phase
- Comprehensive testing and quality control
- Experienced manufacturing partners with IoT device experience

**Document Status:** Ready for manufacturer review and quotation Next Steps: RFQ distribution, NDA execution, technical discussions